



- 895 MHz Low-loss SAW Filter
- Surface Mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)

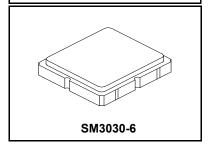


### **Absolute Maximum Ratings**

Rating	Value	Units
Input Power Level	15	dBm
DC Voltage on any Non-ground Terminal	5	V
Operable Temperature Range	-45 to +125	°C
Specification Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Solder Reflow Temperature, 10 seconds, 5 cycles maximum	260	°C

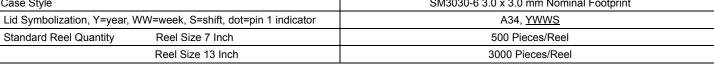
## **SF2287E**

## 895 MHz **SAW Filter**



#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units	
Center Frequency	f <sub>C</sub>			895		MHz	
Minimum Insertion Loss, 894 to 896 MHz	IL <sub>MIN</sub>			2.6	3.2	dB	
Amplitude Ripple, 894 to 896 MHz				0.3	1.2	dB <sub>P-P</sub>	
Input/Output Return Loss, 894 to 896 MHz			9	12		dB	
Attenuation, Referenced to 0 dB							
10 to 851 MHz			40	56			
1030 to 1100 MHz			40	54		dB	
1100 to 2600 MHz			25	33		7	
Source Impedance	Z <sub>S</sub>			50		0	
Load Impedance	Z <sub>L</sub>			50		Ω	
Temperature Coefficient of Frequency	TCf			-36		ppm/°C	
Case Style		SM3	030-6 3.0 x 3	.0 mm Nomina	I Footprint		
Lid Symbolization V=year W/V=week S=shift dot=nin 1 indicator			Δ3.	4 V\\\\\\C			





### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.

Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.

Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.

"LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

The design, manufacturing process, and specifications of this filter are subject to change.

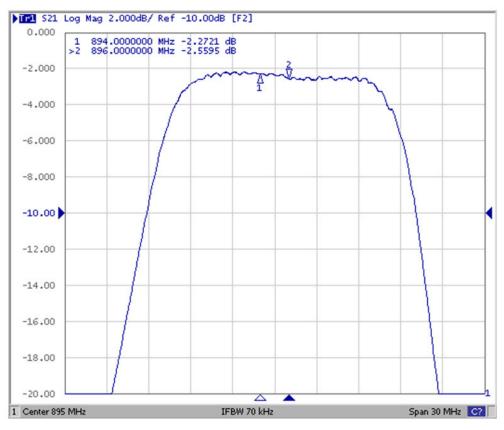
Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port

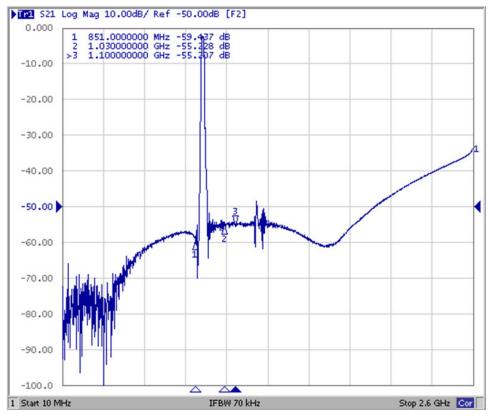
2, so that the filter must always be installed in one direction per the circuit design.

US and international patents may apply.

Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

## **Frequency Characteristics**



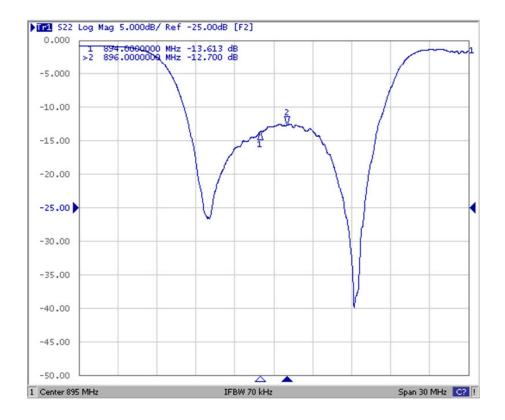


## **Reflection Functions**

**S11** 

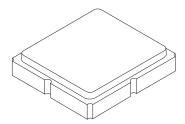


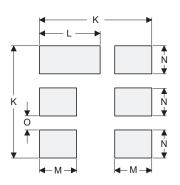
**S22** 



# **SM3030-6 Case**

# 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





PCB Land Pattern Top View

### **Case and PCB Footprint Dimensions**

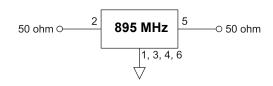
Dimension		mm			Inches	
Dimension	Min	Nom	Max	Min	Nom	Max
Α	-	3.00	-	-	0.118	-
В	-	3.00	-	-	0.118	-
С	-	-	1.40	-	-	0.055
D	-	0.90	-	-	0.035	-
E	-	2.80	-	1	0.110	-
F	-	1.60	-	-	0.063	-
G	-	0.85	-	-	0.033	-
Н	-	1.50	-	-	0.059	-
I	-	0.60	-	-	0.024	-
J	-	1.30	-	-	0.051	-
K	-	3.20	-	-	0.126	-
L	-	1.70	-	-	0.067	-
М	-	1.05	-	-	0.041	-
N	-	0.81	-	-	0.032	-
0	-	0.38	-	-	0.015	-

### **Case Materials**

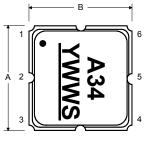
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				

### **Electrical Connections**

Connection	Terminals
Input	2
Output	5
Ground	All Others

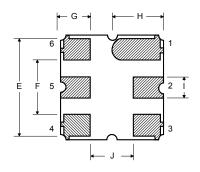


### **TOP VIEW**

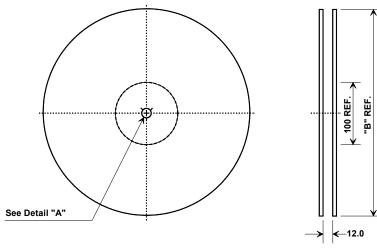




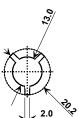
### **BOTTOM VIEW**



### **Tape and Reel Specifications**



"B"		Quantity Per Reel	
Inches	millimeters	<b></b>	
7	178	500	
13	330	3000	



### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions				
Ao	3.35 mm			
Во	3.35 mm			
Ko	1.40 mm			
Pitch	8.0 mm			
W	12.0 mm			

